# PATENT ASSIGNMENT

## Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Subhas Bothra	08/19/2011
Steven L. Skala	06/26/2011
Emmanuel DeMuizon	07/04/2011

#### **RECEIVING PARTY DATA**

Name:	Philips Semiconductors, Inc.
Street Address:	1251 Avenue of the Americas
City:	New York
State/Country:	NEW YORK
Postal Code:	10020

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Patent Number:	6261939

## **CORRESPONDENCE DATA**

Fax Number: (408)474-9082

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 3474431592

Email: david.schaeffer@nxp.com

Correspondent Name: David L. Schaeffer

Address Line 1: 1109 McKay Drive, M/S 41 SJ
Address Line 2: NXP Semiconductors, IP&L
Address Line 4: San Jose, CALIFORNIA 95131

NAME OF SUBMITTER: David L. Schaeffer

Total Attachments: 3

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## NUNC PRO TUNC ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, as a below named Assignor, hereby sell, and assign, and transfer, nunc pro tunc effective January 11, 1999, my entire and exclusive right, title, and interest in the following to Philips Semiconductors, Inc., having a place of business at 1251 Avenue of the Americas, New York, New York 10020, United States, its successors, assigns, and legal representatives, including any nominees (collectively "the Assignee"):

my/our invention relating to "PAD METALLIZATION OVER ACTIVE CIRCUITRY", for which U.S. Patent No. 6,261,939 was granted on July 17, 2001, (based upon U.S. Patent Application No. 09/472,384, filed on December 29, 1999); and

all rights in and to said patent, and all United States, foreign and international patent applications associated therewith, based thereon, or claiming priority therefrom including, but not limited to, any and all provisionals, non-provisionals, divisions, continuations, continuations-in-part, reexaminations, reissues, and extensions thereof, and the right to claim priority thereto, and the entire and exclusive right, title, and interest in and to any and all patents granted on these applications.

I further confirm that, as of **January 11**, **1999**, I had authorized and requested the Patent Office officials in the United States and in any and all foreign countries to issue any and all Letters Patent when granted, solely to **Philips Semiconductors**, **Inc.** for its sole use, and that of its successors, assigns, and legal representatives.

I further confirm that, as of January 11, 1999, I had covenanted and agreed and continue to covenant and agree to provide my cooperation to enable the Assignee to enjoy the foregoing right, title, and interest to the fullest extent. Upon request at the expense of the Assignee, I agreed and agree to execute all papers, take all rightful oaths, testify in all legal proceedings including patent prosecutional actions and infringement actions, and do all other such acts which may be necessary, desirable, or convenient for securing and maintaining patents on the foregoing invention or for perfecting title thereto in the Assignee.

I also hereby confirm that, as of January 11, 1999, I had transferred unto the Assignee, its successors, legal representatives and assigns, all claims for damages by reason of past infringement of any patents based in whole or part upon said application, the right to sue for and collect the same for their own use and for the use and enjoyment of their successors, legal representatives or other assigns and do hereby assign and set over unto Assignee, its successors and assigns, nunc pro tune effective January 11, 1999, all such claims and rights.

I certify that I have the full right to convey the above rights.

$\frac{2/19/2011}{\text{Date}}$	Subhas Bothra Subhas Bothra	Assignor
Date	Steven L. Skala	Assignor
Date	Emmanuel DeMuizon	Assignor

PATENT REEL: 026784 FRAME: 0492

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Date	Subhas Bothra	Assignor
<u>何</u> 人6 / 2-0 / ( Date	Steven L. Skala	Assignor
Date	Emmanuel DeMuizon	Assignor

PATENT REEL: 026784 FRAME: 0493

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		Assignor
Date	Subhas Bothra	n <b>S</b> jen
Date	Steven L. Skala	Assigno
- 07/04/2011		Assigno
Date	Emmanuel DeMuizon	

PATENT REEL: 026784 FRAME: 0494

**RECORDED: 08/22/2011**